

TABLE 1				
Variant	Label text			
001	ChangeMe!			
002	ChangeMe!			

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9073	REV: A	SVN REV	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 8/5/20	3:03:34	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9073	REV: A	SVN REV	: Not In VersionControl
	Bottom Overlay <- 390001			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 8/5/20	013 3:03:35	PM	TEXAS INSTRUMENTS

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